

C0805X221JDGACTU

Aliases (C0805X221JDGAC7800) SMD Comm COG HV Flex, Ceramic, 220 pF, 5%, 1,000 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 0805, 0.6 mm



Click here for the 3D model.

General Information	
Series	SMD Comm COG HV Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra- Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	14 mg
Shelf Life	78 Weeks
MSL	1

		Specifications	
	0805	Capacitance	220
	2mm +/-0.3mm	Measurement Condition	1 M
	1.25mm +/-0.3mm	Tolerance	5%
	1.25mm +/-0.15mm	Voltage DC	100
	0.6mm MIN	Dielectric Withstanding Voltage	1,20
	0.5mm +/-0.25mm	Temperature Range	-55
		Temp. Coefficient	CO
ns		Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30
	T&R, 180mm, Plastic Tape		

Chip Size

Packaging Specification Packaging 2500 Packaging Quantity

Dimensions

L W т s В

Specifications	
Capacitance	220 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	1000 VDC
Dielectric Withstanding Voltage	1,200 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MegaHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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